Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK2599

Chopper Regulator, DC-DC Converter and Motor Drive Applications

 $\begin{array}{ll} \bullet & \text{Low drain-source ON resistance} & : R_{DS} \, (\text{ON}) = 2.9 \, \Omega \, (\text{typ.}) \\ \bullet & \text{High forward transfer admittance} & : | \, Y_{fs} | = 1.7 \, S \, (\text{typ.}) \\ \bullet & \text{Low leakage current} & : \, I_{DSS} = 100 \, \mu A \, (\text{max}) \, (\text{V}_{DS} = 500 \, \text{V}) \\ \bullet & \text{Enhancement-mode} & : \, V_{th} = 2.0 {\sim} 4.0 \, V \, (\text{V}_{DS} = 10 \, V, \, I_{D} = 1 \, \text{mA}) \\ \end{array}$

Maximum Ratings (Ta = 25°C)

Charac	eteristics	Symbol	Rating	Unit
Drain-source volta	ge	V_{DSS}	500	V
Drain-gate voltage	e (R _{GS} = 20 kΩ)	V_{DGR}	500	V
Gate-source volta	ge	V _{GSS}	±30	V
Drain current	DC (Note 1)	I _D	2	Α
	Pulse (t = 1 ms) (Note 1)	I _{DP}	5	Α
	Pulse (t = 100 µs) (Note 1)	I _{DP}	12	Α
Drain power dissip	ation	P _D	1.3	W
Single pulse avala	nche energy (Note 2)	E _{AS}	112	mJ
Avalanche current		I _{AR}	2	Α
Repetitive avalanc	he energy (Note 3)	E _{AR}	0.13	mJ
Channel temperatu	ıre	T _{ch}	150	°C
Storage temperatu	re range	T _{stg}	-55~150	°C

Weight: 0.54 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient	R _{th (ch-a)}	96.1	°C/W	

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 48.4 mH, $R_G = 25 \Omega$, $I_{AR} = 2 \text{ A}$

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device.

Please handle with caution.



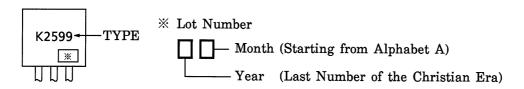
Electrical Characteristics (Ta = 25°C)

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V		_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{GS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 500 V, V _{DS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_	_	V
Gate threshold v	oltage/	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 1 A	_	2.9	3.2	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 1 A	8.0	1.7	_	S
Input capacitano	e	C _{iss}			380	_	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	40	_	pF
Output capacitance		Coss]	_	120	_	
Switching time	Rise time	t _r	$V_{GS} \stackrel{10V}{\underset{0V}{\text{OUt}}} \stackrel{I_{D}=1A}{\underset{R_{L}=200\Omega}{\text{V}}} V_{out}$ $V_{DD} \stackrel{\vdots}{\Rightarrow} 200V$ $Duty \leq 1\%, \ t_{W} = 10 \mu s$	_	15	_	
	Turn-on time	t _{on}		_	25	_	ne
	Fall time	t _f		_	20	_	- ns
	Turn-off time	t _{off}			80	_	
Total gate charge (Gate-source plus gate-drain)		Qg			9		
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$		5	_	nC
Gate-drain ("miller") charge		Q_{gd}			4	_	

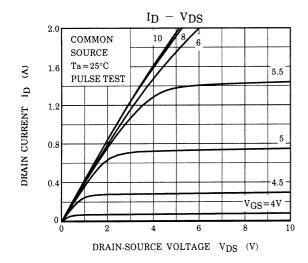
Source-Drain Ratings and Characteristics (Ta = 25°C)

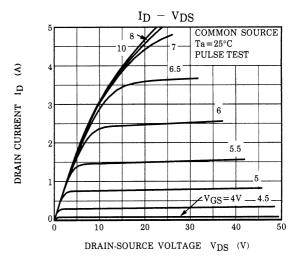
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	2	Α
Pulse drain reverse current (Note 1)	I _{DRP}	t = 1 ms	_	_	5	Α
	I _{DRP}	t = 100 μs			12	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = 2 A, V _{GS} = 0 V	_	_	-1.5	V
Reverse recovery time	t _{rr}	I _{DR} = 2 A, V _{GS} = 0 V dI _{DR} / dt = 100 A / μs	_	1000	_	ns
Reverse recovered charge	Q _{rr}	dl _{DR} / dt = 100 A / μs	_	3.5	_	μC

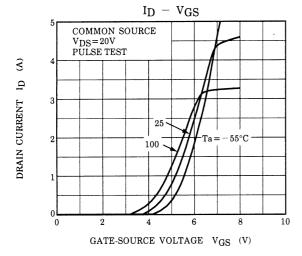
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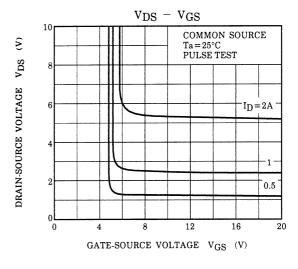


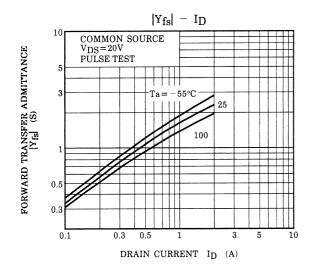
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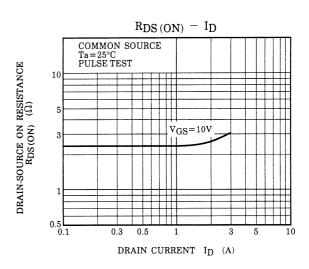


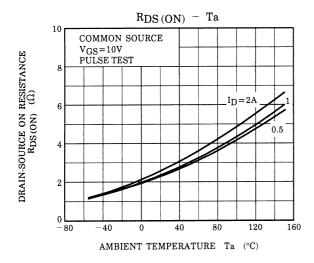


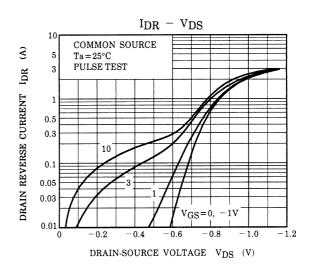


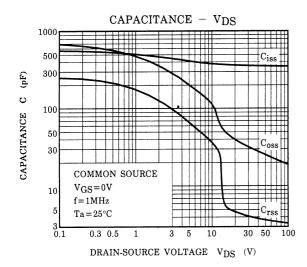


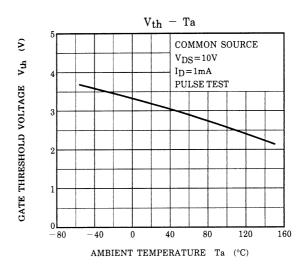


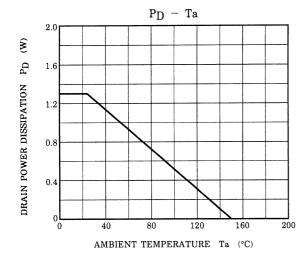


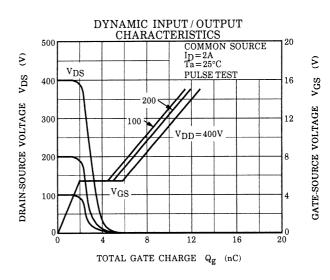




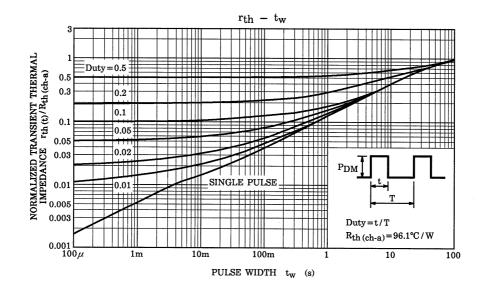


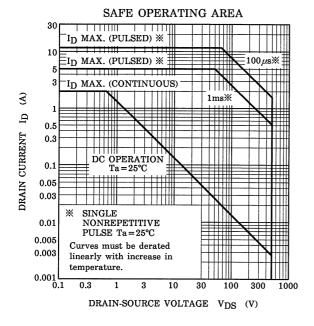


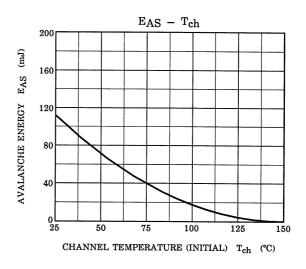


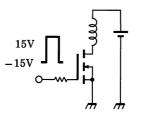


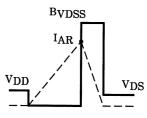
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TEST CIRCUIT

WAVE FORM

$$R_G$$
 = 25 Ω
 V_{DD} = 90 V, L = 48.4 mH

$$EAS = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

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